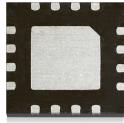
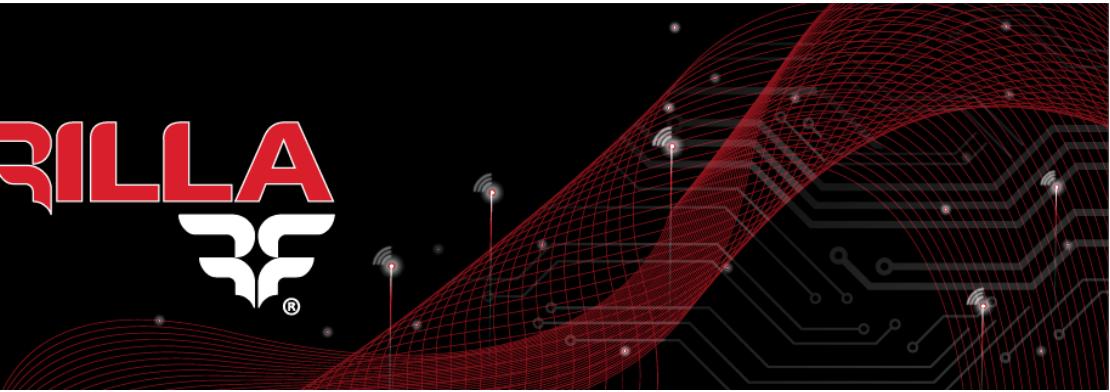




## DATA SHEET



### GRF5504

### High Efficiency 3.5 Watt Power Amplifier 100 to 550 MHz

RELEASE Ø DATA SHEET

#### FEATURES

- Flexible Bias Voltage and Current
- 125 mA Native Mode Quiescent Current Consumption
- 5 V Supply Voltage
- -40 to 85 °C Operating Temperature Range
- Compact 3 x 3 mm QFN-16 Package
- Process: InGaP HBT

#### References: 5 V / 125 mA / 460 MHz

- Gain: 41 dB
- OP1dB: 34.3 dBm
- PSAT: 35.3 dBm
- PAE: 61% @ PSAT
- Evaluation Board Noise Figure: 4.2 dB

#### DESCRIPTION

The GRF5504 is a high efficiency PA that delivers up to 3.5 watts at PSAT with V<sub>CC</sub> at 5 volts and a low I<sub>CCQ</sub> of 125 mA. PAE at PSAT is roughly 61%.

The device can be tuned over a range of frequencies from 100 to 550 MHz with typical fractional bandwidths of 3 to 5%.

For frequencies in the 700-1000 MHz range, GRF5509 offers slightly higher output power and higher efficiency with the same package and pinout.

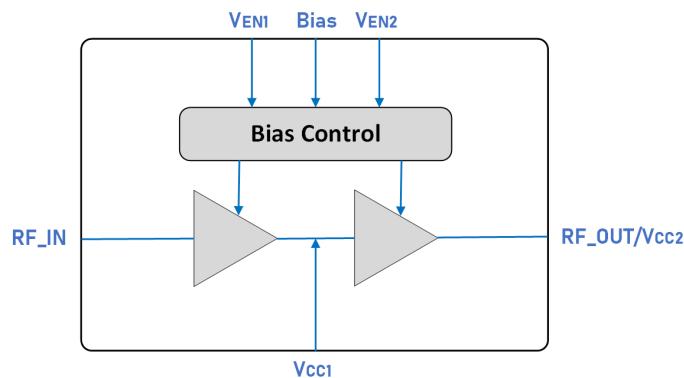
Please consult with the GRF applications engineering team for custom tuning/evaluation board data.

Additional tunes can be found on the GRF5504 "Custom Tunes" product page: [GRF5504 Custom Tunes](#).

#### APPLICATIONS

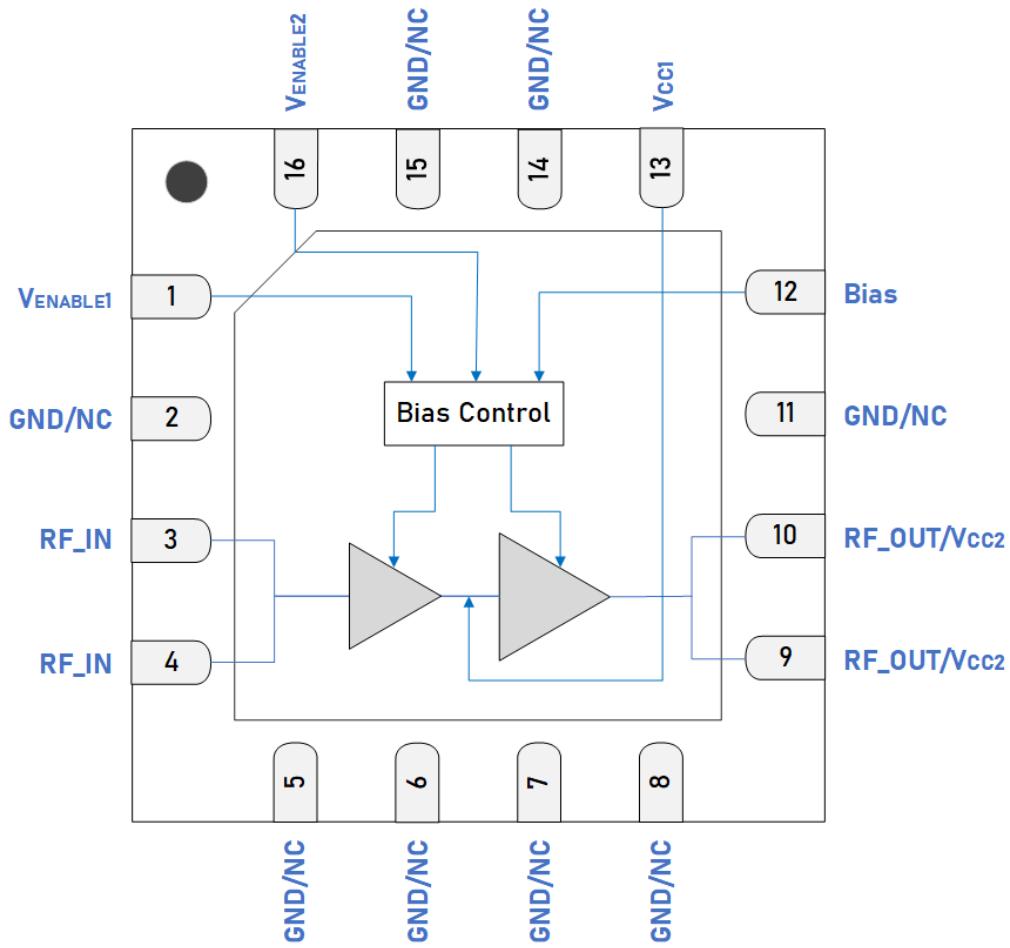
- UHF
- Automatic Meter Reader
- IOT
- TETRA

#### BLOCK DIAGRAM



#### ORDERING INFORMATION

[Buy it Now](#)



## Pin Assignments

Pin	Name	Description	Note
1	V <sub>ENABLE1</sub>	Enable1 Voltage Input	V <sub>EN1</sub> and series resistor set I <sub>CCQ1</sub> for the input stage. V <sub>EN1</sub> ≤ 0.2 volts disables device.
2, 5, 6, 7, 8, 11, 14, 15	GND/NC	Ground or No Connect	No internal connection to die. These pins can be left unconnected, or be connected to ground (recommended). Use a via as close to the pin as possible if grounded.
3, 4	RF_IN	RF Input	Pins 3 & 4 tied together on system board. Internally matched 50 Ω. An external DC blocking capacitor must be used.
9, 10	RF_OUT/V <sub>CC2</sub>	PA Output/Bias Voltage	Pins 9 & 10 tied together on system board. V <sub>CC2</sub> must be applied to this pin via a RF choke.
12	Bias	Bias Circuit Supply	Connect to V <sub>CC2</sub> through external resistor.
13	V <sub>CC1</sub>	Bias Voltage	Connect to V <sub>CC1</sub> through external resistor.
16	V <sub>ENABLE2</sub>	Enable2 Voltage Input	V <sub>EN2</sub> and series resistor set I <sub>CCQ2</sub> for the output stage. V <sub>EN2</sub> ≤ 0.2 volts disables device.
PKG BASE	GND	Ground	Provides DC and RF ground for PA, as well as thermal heat sink. Recommend multiple 8 mil vias beneath the package for optimal RF and thermal performance. Refer to evaluation board top layer graphic on schematic page.

## Truth Table

Pin	Logic State	Condition
V <sub>EN1</sub>	LOW	Stage 1 Amplifier Off
	HIGH	Stage 1 Amplifier On
V <sub>EN2</sub>	LOW	Stage 2 Amplifier Off
	HIGH	Stage 2 Amplifier On

## Absolute Ratings

Parameter	Symbol	Min.	Max.	Unit
Supply Voltage	V <sub>CC</sub>	* 2.7	5.5	V
Transient Average RF Input Power: (Load VSWR < 2:1	P <sub>IN</sub> Max		20	dBm
Operating Temperature (Package Base)	T <sub>PKG BASE</sub>	-40	85	°C
Maximum Junction Temperature (MTTF > 10 <sup>6</sup> Hours)	T <sub>J MAX</sub>		170	°C
Stage 1 Maximum Dissipated Power (DC only. No RF applied)	P <sub>DISS MAX</sub>		500	mW
Stage 2 Maximum Dissipated Power (DC only. No RF applied)	P <sub>DISS MAX</sub>		1750	mW
Ruggedness: V <sub>CC</sub> = 5 V at P <sub>SAT</sub> (all phase angles)	VSWR		TBD	

\* The device can be operated in saturated applications with V<sub>CC</sub> < 2.7 V. Please consult with the GRF applications team for details.

## Electrostatic Discharge

Human Body Model	HBM	250		V
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## Storage

Storage Temperature	T <sub>STG</sub>	-65	150	°C
Moisture Sensitivity Level	MSL		1	--



**Caution! ESD Sensitive Device.**

**Exceeding Absolute Maximum Rating conditions may cause permanent damage.**

Note: For additional information, please refer to [Manufacturing Note MN-001 - Packaging and Manufacturing Information](#).



All Guerrilla RF products are provided in RoHS compliant lead (Pb)-free packaging. For additional information, please refer to the [Certificate of RoHS Compliance](#).

## Recommended Operating Conditions

Parameter	Symbol	Specification			Unit	Condition
		Min.	Typ.	Max.		
Supply Voltage	V <sub>CC</sub>	2.7	5	5.5	V	
Operating Temperature Range	T <sub>PKG BASE</sub>	-40		85	°C	
RF Frequency Range	F <sub>RF</sub>	100	460	550	MHz	Typical application schematic using the 100 to 550 MHz tuning set ( <b>notes 1 &amp; 2</b> ).
RF1 Port Impedance	Z <sub>RFIN</sub>		50		Ω	Single-ended with 2 element match.
RF2 Port Impedance	Z <sub>RFOUT</sub>		50		Ω	Single -ended with 2 element match.

**Note 1:** Operation outside of this range is supported by using different custom tunes. Examples of other optimized tunes can be found here: [GRF5504 Custom Tunes](#)

**Note 2:** Contact the Guerrilla RF Applications team for guidance on optimizing the tuning of the device for alternative bands.

## Nominal Operating Parameters - General

Parameter	Symbol	Specification			Unit	Condition
		Min.	Typ.	Max.		
Supply Current	I <sub>CCQ</sub>	90	125	160	mA	V <sub>CC</sub> = 5 V, V <sub>EN1</sub> = V <sub>EN2</sub> = 5 V.
Enable Current 1	I <sub>ENABLE1</sub>		1.0		mA	
Enable Current 2	I <sub>ENABLE2</sub>		0.4		mA	

### Disabled Mode

Supply Current (Leakage)	I <sub>CC</sub>		0.03		µA	V <sub>CC</sub> = 5 V, V <sub>EN1</sub> = V <sub>EN2</sub> = 0 V.
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### Thermal Data

Stage 1 Thermal Resistance (Infrared Scan). DC only. No RF applied.	Θ <sub>JC</sub>		140		°C/W	On standard evaluation board.
Stage 2 Thermal Resistance (Infrared Scan). DC only. No RF applied.	Θ <sub>JC</sub>		33		°C/W	On Evaluation Board.
Therrmal Data Stage 1 and 2: see plot of Junction Temp vs. Output Power.						V <sub>CC</sub> = V <sub>EN1</sub> = V <sub>EN2</sub> = 5 V. On standard evaluation board ( <b>note 3</b> ).

**Note 3:** MTTF > 10<sup>6</sup> hours for T<sub>j</sub> ≤ 170 °C

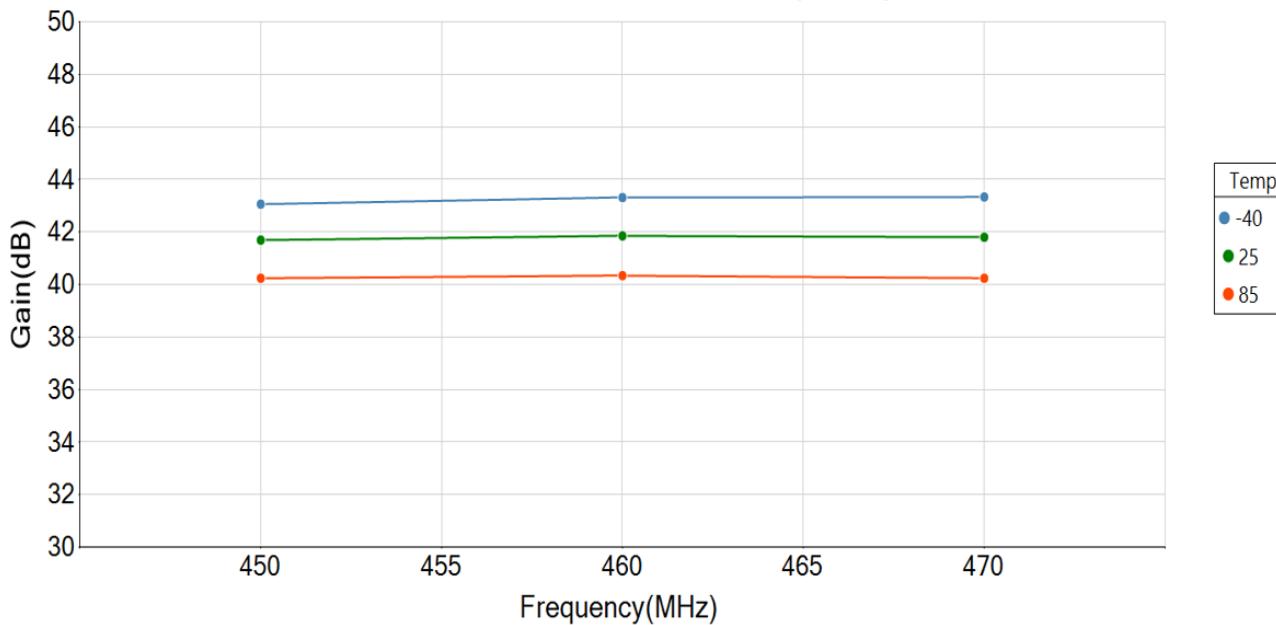
## Nominal Operating Parameters - RF

The following conditions apply unless noted otherwise; typical application schematic,  $V_{CC} = 5\text{ V}$ ,  $50\Omega$  system impedance,  $f_{TEST} = 460\text{ MHz}$ ,  $T_{PKG\ HEAT\ SINK} = 25^\circ\text{C}$ . Evaluation board losses are included within the specifications.

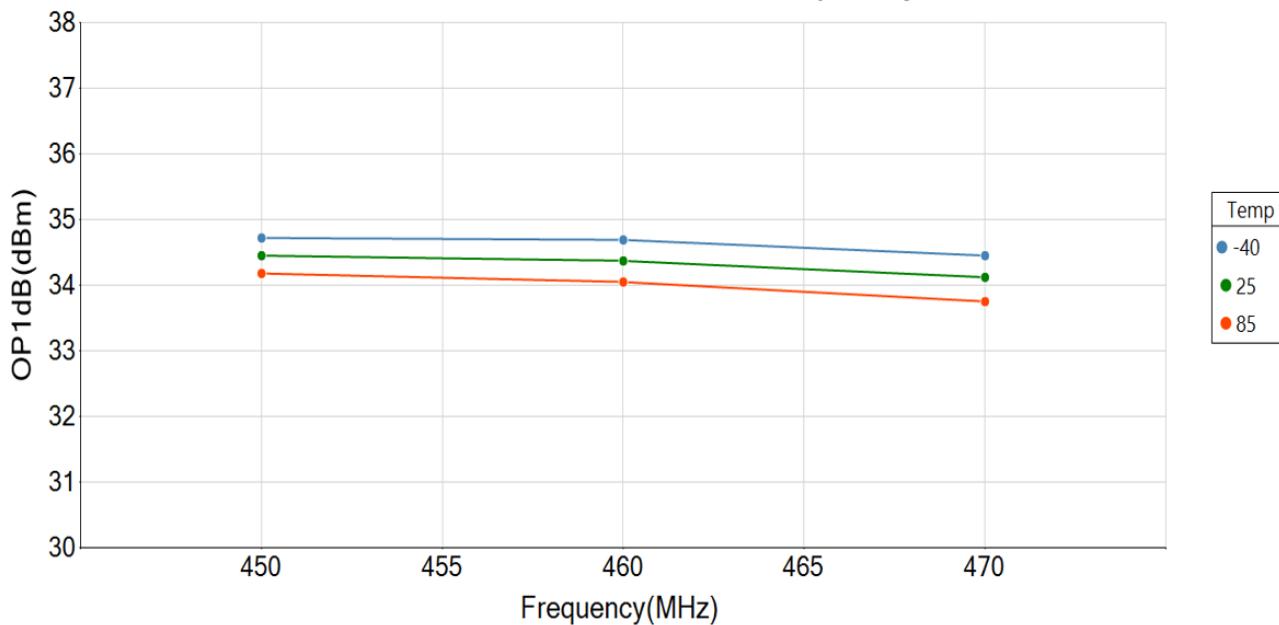
Parameter	Symbol	Specification			Unit	Condition
		Min.	Typ.	Max.		
Small Signal Gain	S21		41		dB	$P_{IN} = -25\text{ dBm}$ .
Evaluation Board Noise Figure	NF		4.2		dB	
Saturated Output Power	$P_{SAT}$	33.8	35.3		dBm	RF Input Power = 0 dBm.
Power Added Efficiency (@ $P_{SAT}$ )	PAE		61		%	RF Input Power = 0 dBm
Output 1 dB Compression Power	OP1dB		34.3		dBm	CW input.
Switching Rise Time	$T_{RISE}$		14		$\mu\text{s}$	@ $P_{SAT}$
Switching Fall Time	$T_{FALL}$		1		$\mu\text{s}$	@ $P_{SAT}$

## GRF5504 Typical Operating Curves: 450 to 470 MHz Tune

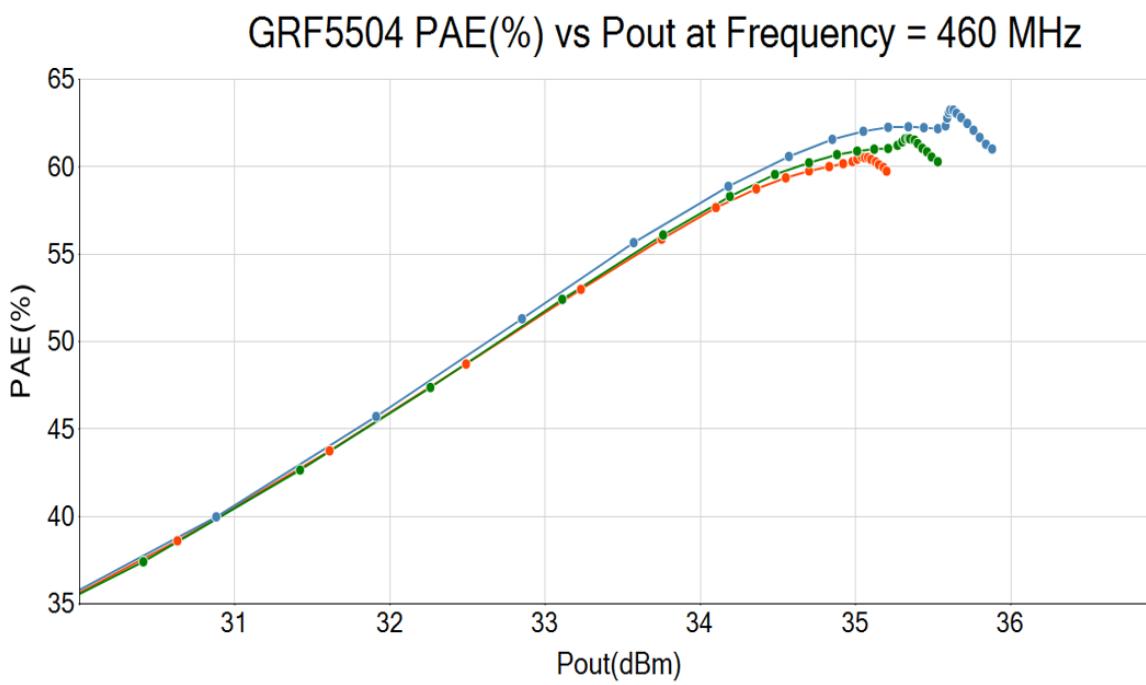
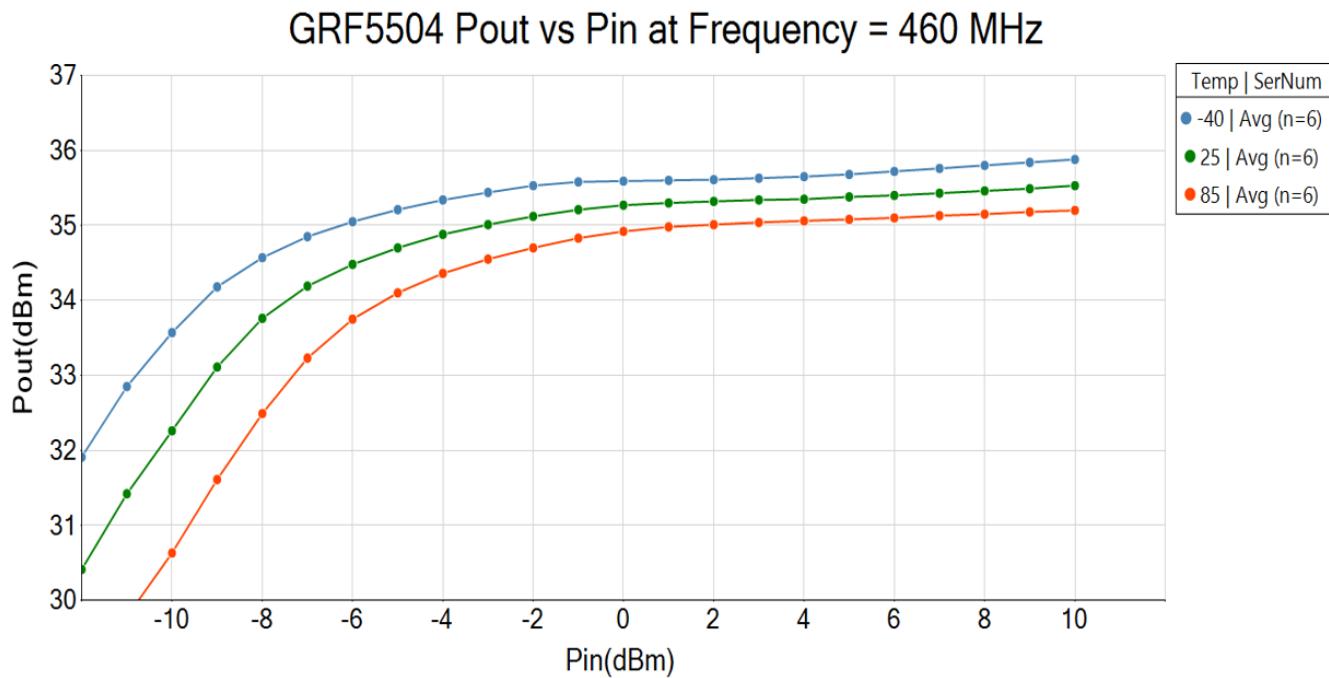
GRF5504 Gain vs Frequency



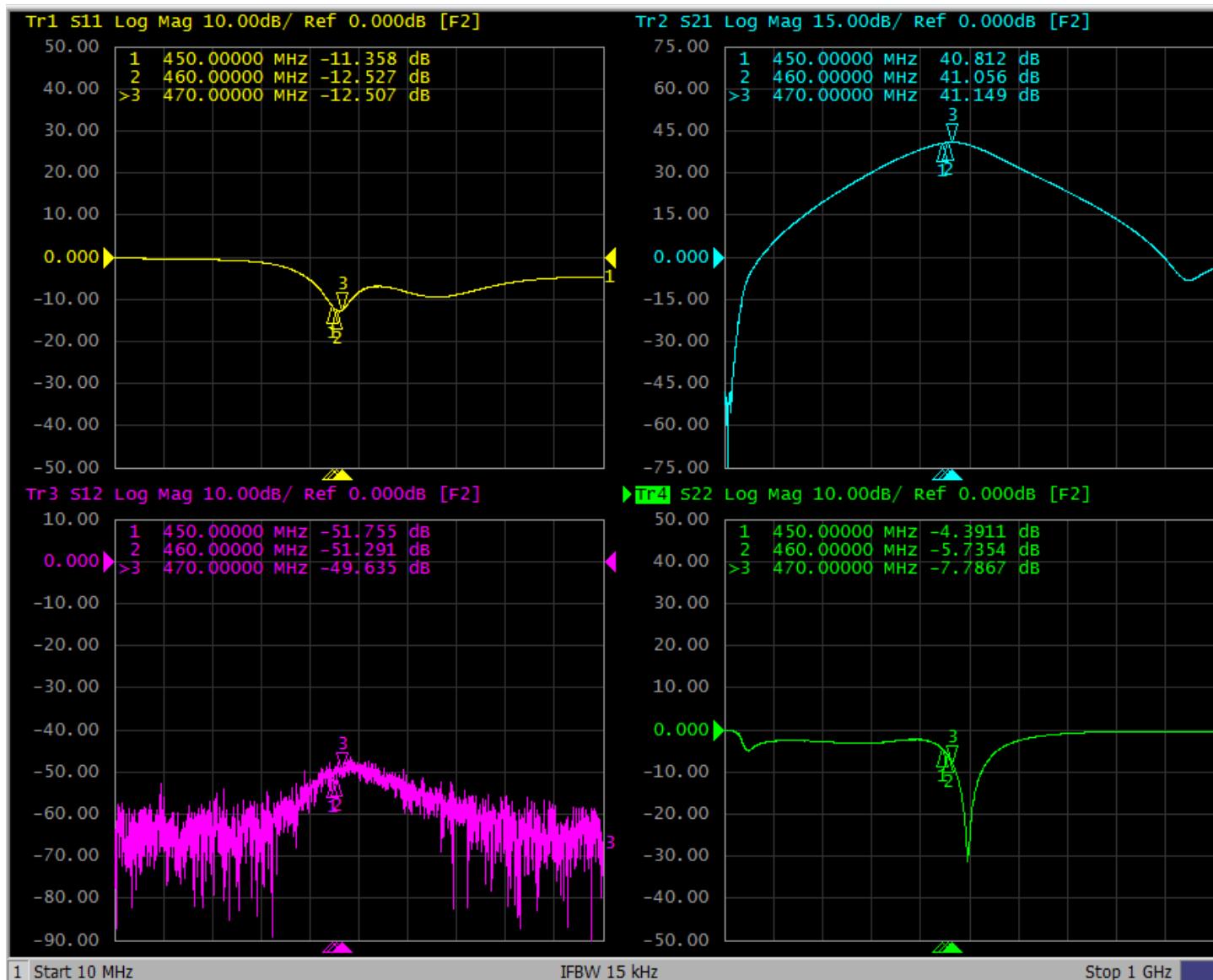
GRF5504 OP1dB vs Frequency



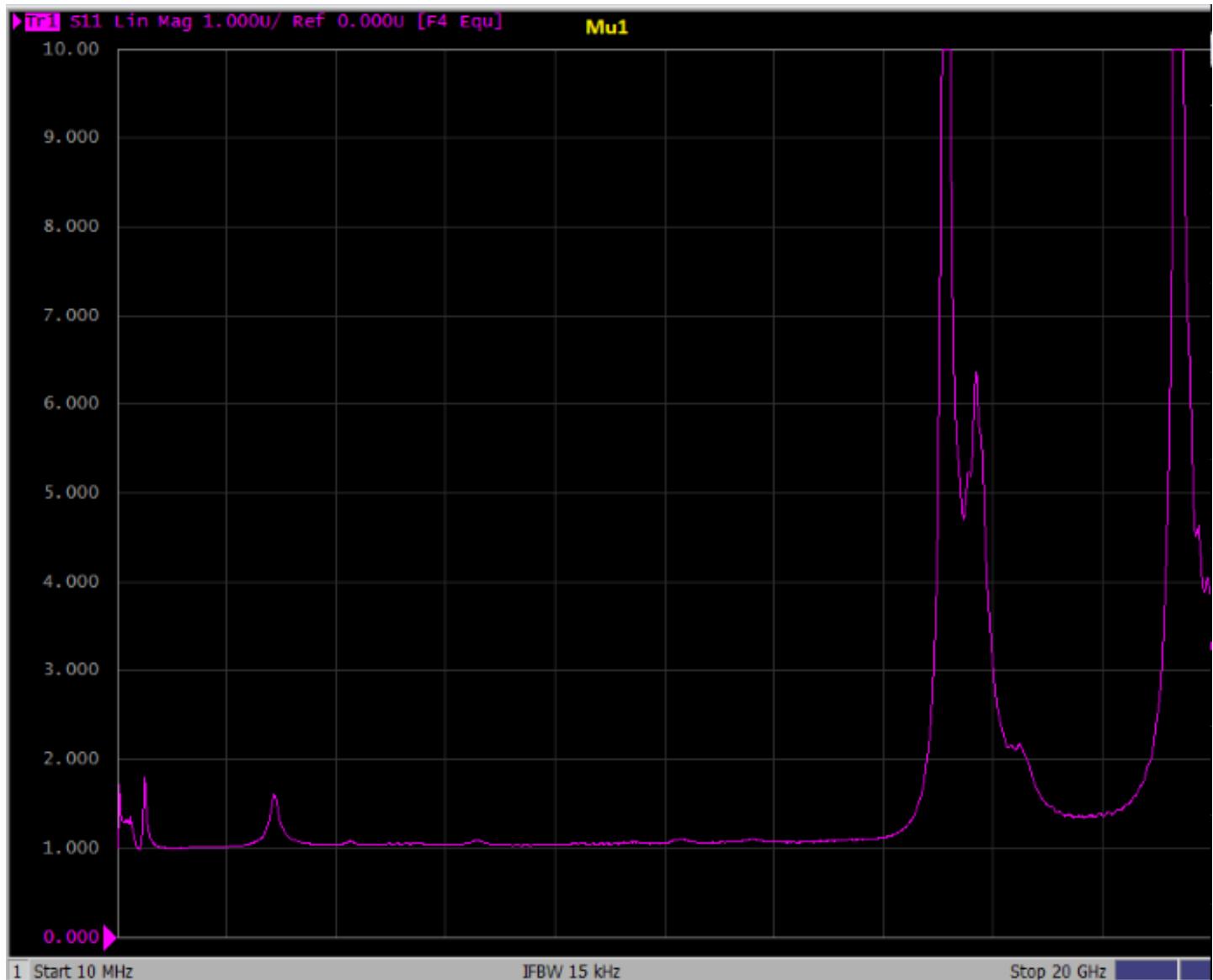
## GRF5504 Typical Operating Curves: 450 to 470 MHz Tune



## GRF5504 Typical Operating Curves: S-Parameters (450 to 470 MHz Tune)



## GRF5504 Typical Operating Curves: Stability Mu (10 MHz to 20 GHz)



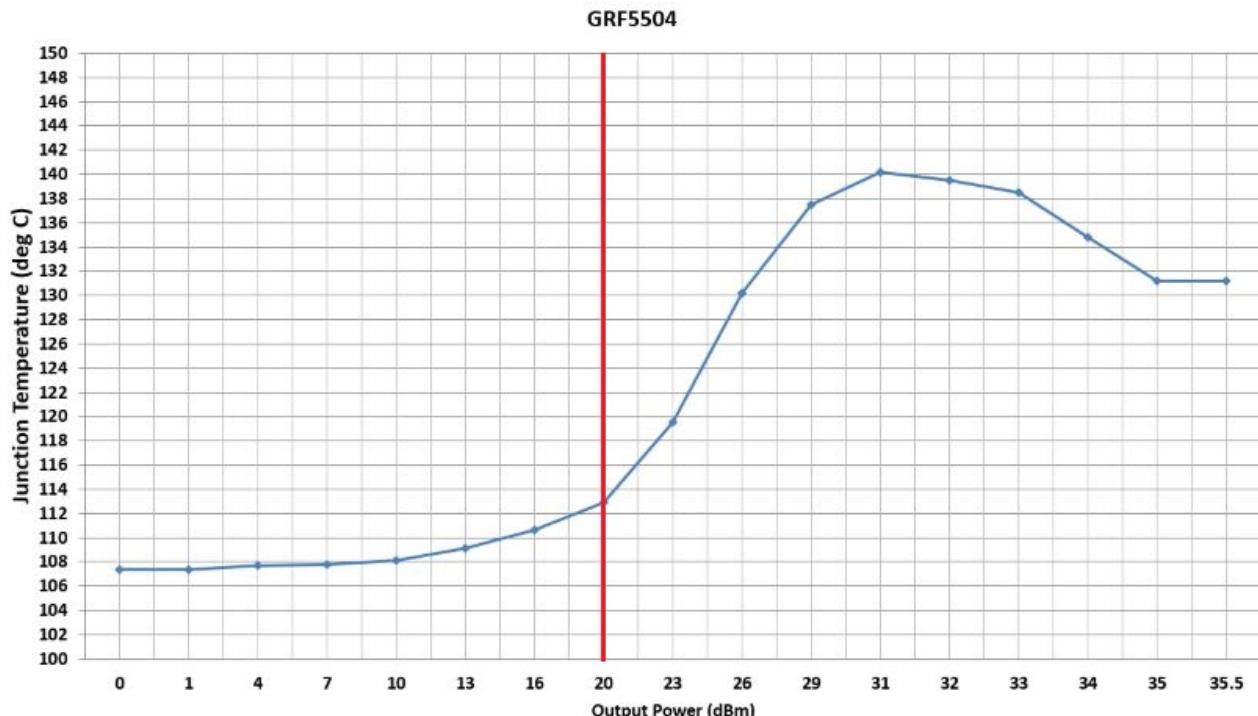
Note: Mu factor  $\geq 1.0$  implies unconditional stability.

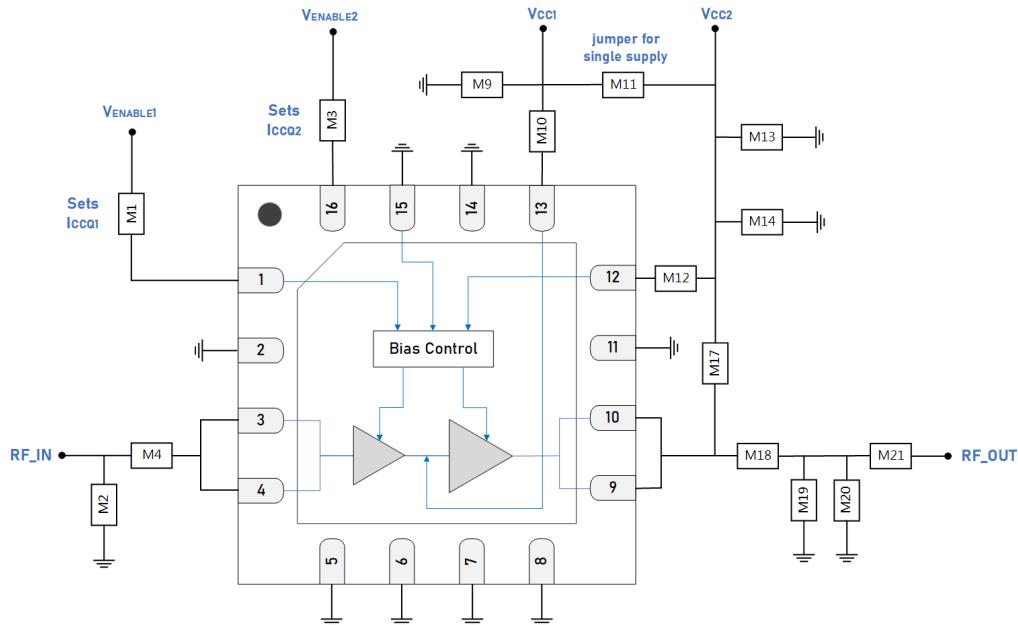
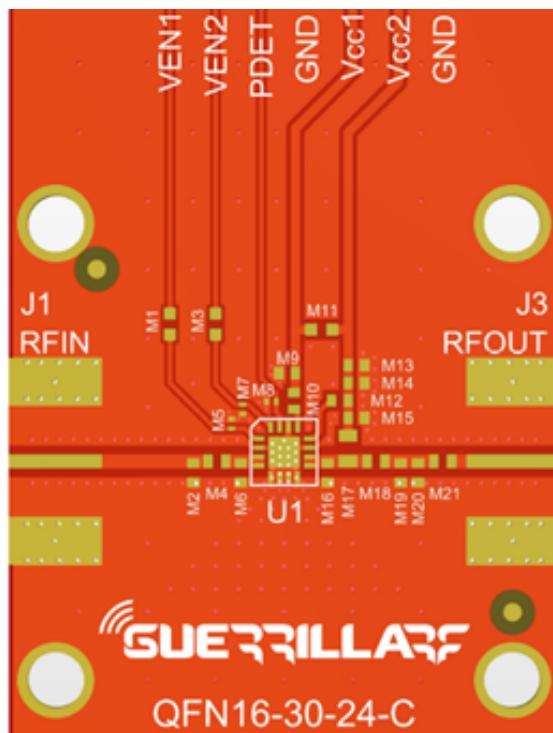
## GRF5504 Junction Temperature (per application schematic @ 85 °C)

GRF5504 being a 2-stage device sees one of the stages governing junction temperature over power sweep.

Red line = 20 dBm where  $T_J$  is equivalent in both stages. At left of red line, stage 1 governs  $T_J$  (Q1  $T_J$  is higher).

To the right of red line, stage 2 governs  $T_J$  (Q2  $T_J$  is higher).




**GRF5504 Standard Evaluation Board Schematic**

**GRF5504 Evaluation Board Assembly Diagram**

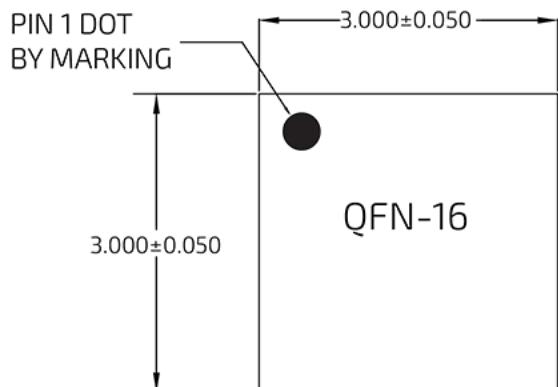
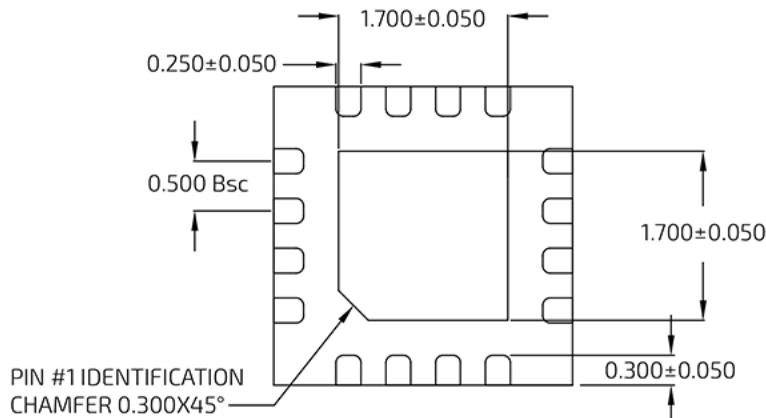
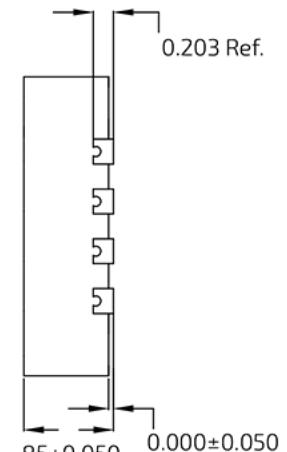
## **GRF5504 Evaluation Board Assembly Diagram Reference: 450 to 470 MHz Tune**

**Standard Evaluation Board Bias:  $V_{CC} = V_{EN1} = V_{EN2} = 5\text{ V}$**

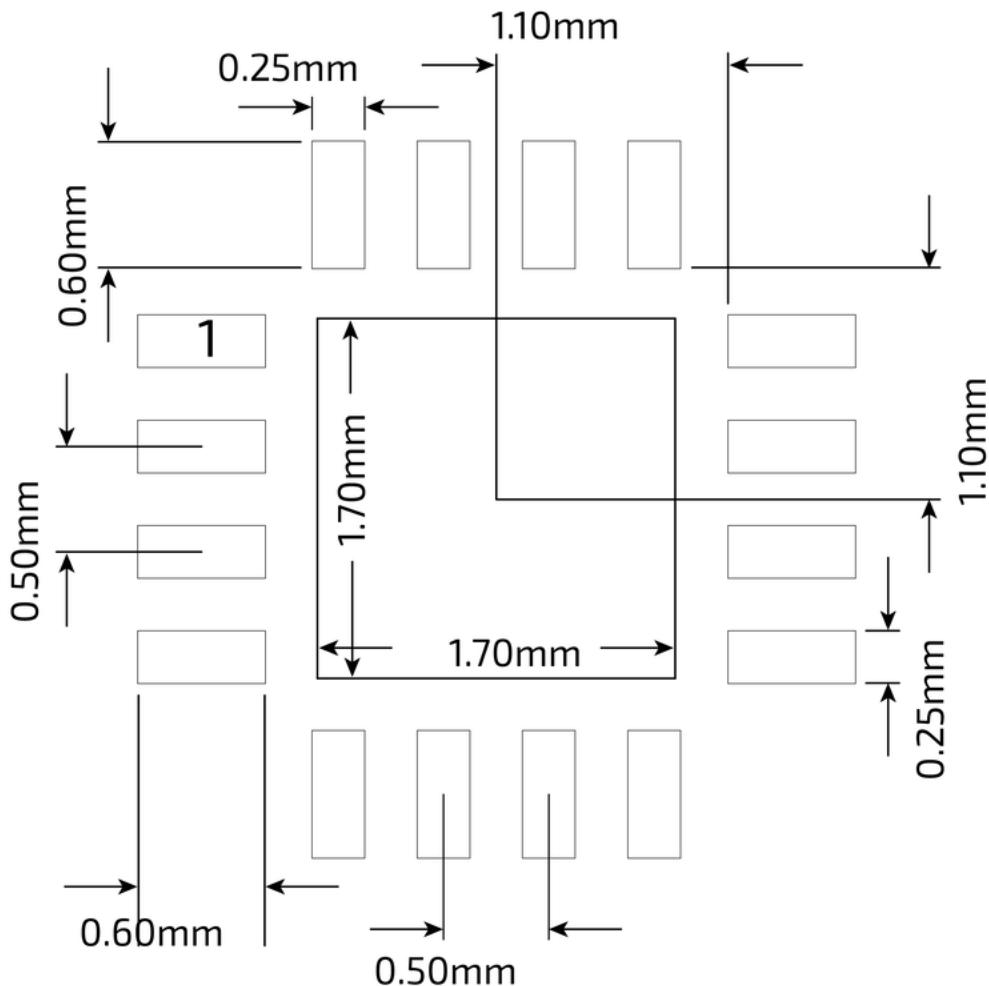
<b>Component</b>	<b>Type</b>	<b>Manufacturer</b>	<b>Family</b>	<b>Value</b>	<b>Package Size</b>	<b>Substitution</b>
M1	Resistor	Various	5%	See table	0402	ok
M2	Inductor	Murata	LQG	8.2 nH	0402	ok
M3	Resistor	Various	5%	See table	0402	ok
M4	Capacitor	Murata	GJM	20.0 pF	0402	ok
M9	Capacitor	Murata	GRM	0.1 $\mu\text{F}$	0402	ok
M10	Inductor	Coilcraft	HP	5.6 nH	0402	ok
M11	Resistor (jumper)	Various	5%	0 $\Omega$	0402	ok
M12	Resistor (jumper)	Various	5%	0 $\Omega$	0402	ok
M13	Capacitor	Murata	GRM	0.1 $\mu\text{F}$	0402	ok
M14	Capacitor	Murata	GRM	100 pF	0402	ok
M17	Inductor	Coilcraft	0908SQ	23.0 nH	0908	ok
M18	Inductor	Coilcraft	DC	2.7 nH	0603	ok
M19	Capacitor	Murata	GJM	22.0 pF	0402	ok
M20	Capacitor	Murata	GJM	3.0 pF	0402	ok
M21	Capacitor	Murata	GRM	100 pF	0402	ok
M5, M6, M7, M8, M15, M16	DNP	--	--	--	--	--
Evaluation Board	QFN16-30-24-C					

## **GRF5504 Bias Resistor Selection Table: Resistors M1 and M3**

<b><math>V_{CC1}\text{ (V)}</math></b>	<b><math>V_{CC2}\text{ (V)}</math></b>	<b><math>V_{EN1} = V_{EN2}\text{ (V)}</math></b>	<b><math>I_{CCQ1}\text{ (mA)}</math></b>	<b><math>I_{CCQ2}\text{ (mA)}</math></b>	<b>Bias R M1</b>	<b>Bias R M3</b>
3	3	3	20	50	1.9 k $\Omega$	2.4 k $\Omega$
3.5	3.5	3.5	20	55	2.7 k $\Omega$	4.5 k $\Omega$
4	4	4	22	65	3.3 k $\Omega$	5.7 k $\Omega$
4.5	4.5	4.5	25	75	3.6 k $\Omega$	6.7 k $\Omega$
5	5	5	30	90	3.3 k $\Omega$	6.8 k $\Omega$


TOP VIEW

BOTTOM VIEW

SIDE VIEW

### QFN 16 3x3mm Package Dimensions


**QFN 16 3x3mm Suggested PCB Footprint (Top View)**

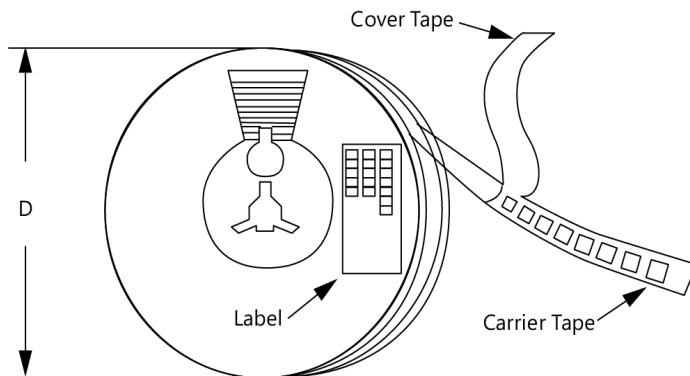
### Package Marking Diagram



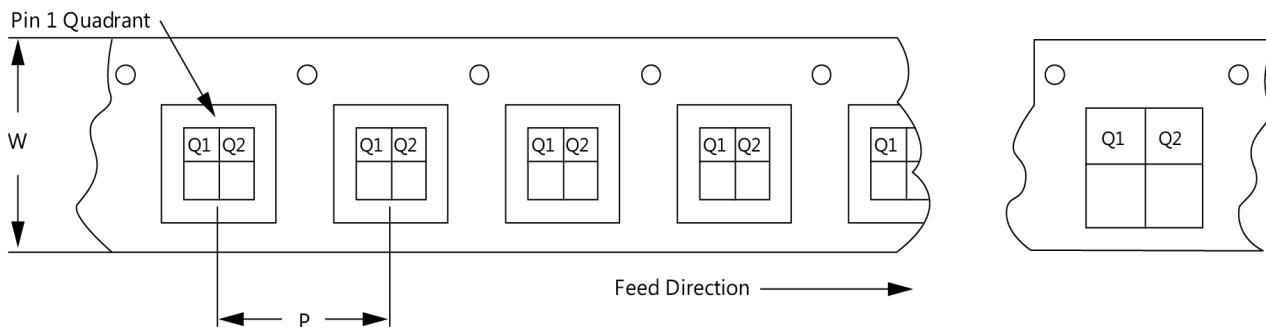
Line 1: "YY" = Year. "WW" = WORK WEEK the Device was assembled.  
 Line 2: "GRF" = Guerrilla RF  
 Line 3: "XXXX" = Device Part Number.

### Tape and Reel Information

Guerrilla RF's tape and reel specification complies with Electronics Industries Association (EIA) standards for "Embossed Carrier Tape of Surface Mount Components for Automatic Handling" (reference EIA-481). Devices are loaded with pins down into the carrier pocket with protective cover tape and reeled onto a plastic reel. Each reel is packaged in a cardboard box. There are product labels on the reel, the protective ESD bag, and the outside surface of the box. For the latest reel specifications and package information (including units/reel), please visit [Package Manufacturing Information | Guerrilla RF](#) ([guerrilla-rf.com](http://guerrilla-rf.com)).



Tape and Reel Packaging with Reel Diameter Noted (D)



Carrier Tape Width (W), Pitch (P), Feed Direction and Pin 1 Quadrant Information

## Revision History

Revision Date	Description of Change
December 19, 2019	Preliminary Data Sheet.
August 25, 2023	Release Ø Data Sheet.
November 7, 2023	Updated Thermal Resistance (Stage 1 & Stage 2). Updated Junction Temperature Plot. Added Psat Lower Limit specification.
January 9, 2025	Updated M18 & M20 on evaluation board BOM.
January 22, 2025	Lowered low end of frequency range from 300 to 100 MHz.

## Data Sheet Classifications

Data Sheet Status	Notes
Advance	S-parameter and NF data based on EM simulations for the fully packaged device using foundry-supplied transistor S-parameters. Linearity estimates based on device size, bias condition and experience with related devices.
Preliminary	All data based on evaluation board measurements taken within the Guerrilla RF Applications Lab. Any MIN/MAX limits represented within the data sheet are based solely on <i>estimated</i> part-to-part variations and process spreads. All parametric values are subject to change pending the collection of additional data.
Release Ø	All data based on measurements taken with <i>production-released</i> material. TYP values are based on a combination of ATE and bench-level measurements, with MIN/MAX limits defined using <i>modelled estimates</i> that account for part-to-part variations and expected process spreads. Although unlikely, future refinements to the TYP/MIN/MAX values may be in order as multiple lots are processed through the factory.
Release A-Z	All data based on measurements taken with production-released material <i>derived from multiple lots which have been fabricated over an extended period of time</i> . MIN/MAX limits may be refined over previous releases as more statistically significant data is collected to account for process spreads.

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